

200mW SOD-323 SURFACE MOUNT Small Outline Flat Lead Plastic Package High Speed Switching Diode

Specification Features:

- High Speed Switching Device (Trr <4.0 nS)
- General Purpose Diodes
- Flat Lead SOD-323 Small Outline Plastic Package
- Surface Device Type Mounting
- RoHS Compliant
- Green EMC
- Matte Tin(Sn) Lead Finish
- Band Indicates Cathode

DEVICE MARKING CODE:

Device Type	Device Marking	
1SS355	S4	

Symbol	Parameter	Value	Units	
PD	Power Dissipation	200	mW	
T _{STG}	Storage Temperature Range	-65 to +150	°C	
TJ	Operating Junction Temperature	+150	°C	
V _R	Reverse Voltage	80	V	
V _{RM}	Repetitive Peak Reverse Voltage	90	V	
I _{FM}	Forward Current	250	mA	
lo	Continuous Forward Current	150	mA	
I _{FRM}	Repetitive Peak Forward Current	500	mA	
I _{FSM}	Peak Forward Surge Current (Pulse Width=1us)	2	A	

Absolute Maximum Ratings T_A = 25°C unless otherwise noted

These ratings are limiting values above which the serviceability of the diode may be impaired.

Electrical Characteristics T_A = 25°C unless otherwise noted

Symbol	Parameter	Test Condition	Limits		Unit
			Min	Max	onit
Bv	Breakdown Voltage	I _R =100μΑ	80		Volts
I _R	Reverse Leakage Current	V _R =80V		100	nA
V _F	Forward Voltage	I _F =100mA		1.2	Volts
T _{RR}	Reverse Recovery Time	I _F =10mA			
		V _R =6V		4	nS
		R _L =100Ω			
С	Capacitance	$V_R=0.5V$, f=1 M_{HZ}		4	pF



Typical Performance Characteristics



Total Capacitance





Forward Voltage vs Ambient Temperature













SOD-323 Package Outline

